



USB-A, USBR-A, USB-AM SERIES

STANDARD & RUGGED USB 2.0

(18.70) .736

(14.60) .575

-SM1

-(17.60) .693

(4.50) .177

(12.00)

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?USB-A, www.samtec.com?USBR-A or www.samtec.com?USB-AM

Insulator Material:

High Temperature Thermoplastic Contact Material: Phosphor Bronze Plating: Gold on Contacts, Nickel on Shell, Tin on Tails
Operating Temp Range:
-50 °C to +85 °C
Voltage Rating:
30 VAC

Contact Resistance:

 $30 \text{ m}\Omega$ Cycles: 1500 (max tested)

Packaging: Packaged and shipped in Bulk Packaging Trays; Trays suitable for automation available

RoHS Compliant:

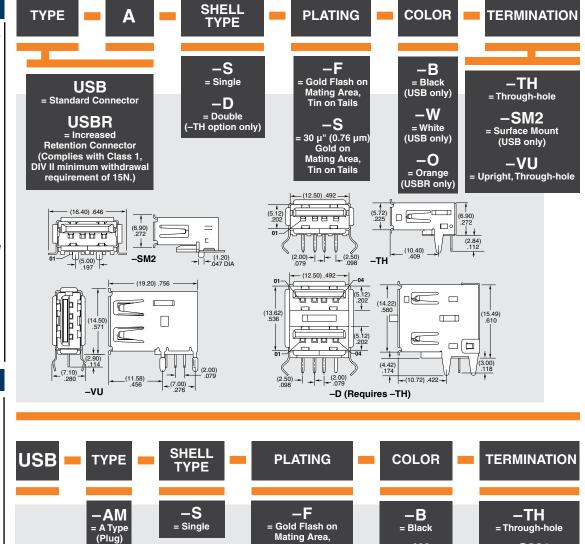
Lead-Free Solderable -TH & -VU=Yes (Wave Solder only)
TID Numbers (USB-A):
USB-A-D-X-X-TH (61001199)
USB-A-S-X-X-TH (61001180)
USB-A-S-X-X-SM2 (61001152)

TID Number (USB-AM): USB-AM-S-X-X-SM (61001154)

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality





Mating Area, Tin on Tails

= 30 μ" (0.76 μm) Gold on Mating Area, Tin on Tails

-W

= White

- (14.70) .579 -

-(17.70) .697

(1.00) .039 DIA

(4.52) .178

(18.80) .740

-SM1

= Surface Mount

(2.62) .103 \ (3.10) .122

(2.00) 1 .079

(4.60) .181

(7.00)

01-

(2.00) .079

(1.45) .057 -

(12.00)

(2.62) (2.87) .103 .113

(4.55) (7.00) .179 .276

←(2.00) .079

↑ ⊕ (2.00) .079